

Special Issue

Advances in Bioprinting

Message from the Guest Editor

3D bioprinting has emerged as one of the leading manufacturing platforms for fabrication of highly complex 3D tissues and/or organs. The field of 3D bioprinting has advanced rapidly over the last few years, notably in the advances of bioprinting technologies and the development of novel printable bio-inks and printing strategies. *Applied Sciences*—“Advances in Bioprinting” publishes research that addresses the needs and goals of 3D bioprinting.

Guest Editor

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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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